



Product Change Notification

113828 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 113828 - 00
Change Title: Intel® Integrated RAID Module,
RMS25CB080, RMT3CB080, RMS25CB040,
RMS25JB080 and RMS25JB040
PCN 113828-00, Transport Media
Update the Outer Box Packaging
Date of Publication: April 30, 2015

Key Characteristics of the Change:

Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	May 15, 2015
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** Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

Description of Change to the Customer:

Intel is implementing the following changes on the outer box for the Intel® Integrated RAID Module RMS25CB080, RMT3CB080, RMS25CB040, RMS25JB080 and RMS25JB040 to meet the new Intel package standards and procedures:

1. Add the International Standard ISO 780 symbols including No.1 “FRAGILE”, No.3 “THIS WAY UP”, and No.6 “KEEP AWAY FROM RAIN”.



2. Update the required recycling symbols including the Internationally Recognized Recycling symbol for paper and the FIBRE ASSOCIATION (FBA) “Corrugated Recycles” symbol.



3. Remove the printed statement of “To save the earth 100% of the package material used is recyclable”.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers, but encourages customers to understand the changes and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
RMS25CB040	924872	G34895-612	G41024-612	G34895-613	G41024-612
RMS25CB080	924871	G34894-612	G35316-612	G34894-613	G35316-612
RMS25JB040	924453	G34901-310	G36714-310	G34901-311	G36714-310
RMS25JB080	924452	G34900-310	G35851-310	G34900-311	G35851-310
RMT3CB080	924873	G34899-612	G41025-612	G34899-613	G41025-612

PCN Revision History:

Date of Revision:

April 30, 2015

Revision Number:

00

Reason:

Originally Published PCN